onsemi

ECOSPARK[®]2 320 mJ, 450 V, N-Channel Ignition IGBT

FGD3245G2-F085, FGB3245G2-F085

General Description

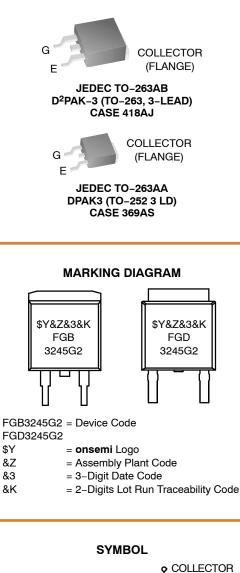
The FGB3245G2–F085 and FGD3245G2 are N-channel IGBTs designed in **onsemi**'s ECOSPARK-2 technology which helps in eliminating external protection circuitry. The technology is optimized for driving the coil in the harsh environment of automotive ignition systems and offers out–standing Vsat and SCIS Energy capability also at elevated operating temperatures. The logic level gate input is ESD protected and features an integrated gate resistor. An integrated zener–circuitry clamps the IGBT's collecter–to–emitter voltage at 450 V which enables systems requiring a higher spark voltage

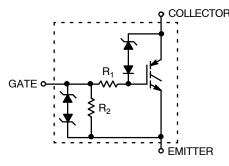
Features

- SCIS Energy = 320 mJ at $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- Low Saturation Voltage
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Ignition Coil Driver Circuits
- Coil On Plug Applications





ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

| Symbol | Parameter | Rating | Unit |
|----------------------|---|-------------|------|
| BV _{CER} | Collector to Emitter Breakdown Voltage (I _C = 1 mA) | 450 | V |
| BV _{ECS} | Emitter to Collector Voltage – Reverse Battery Condition (I _C = 10 mA) | 28 | V |
| E _{SCIS25} | Self Clamping Inductive Switching Energy (Note 1) | 320 | mJ |
| E _{SCIS150} | Self Clamping Inductive Switching Energy (Note 2) | 180 | mJ |
| I _{C25} | Collector Current Continuous, at V_{GE} = 5 V, T_C = 25°C | 41 | А |
| I _{C110} | Collector Current Continuous, at V_{GE} = 5 V, T_C = 110°C | 27 | А |
| V_{GEM} | Gate to Emitter Voltage Continuous | ±10 | V |
| P _D | Power Dissipation Total, at $T_C = 25^{\circ}C$ | 150 | W |
| | Power Dissipation Derating, for $T_C > 25^{\circ}C$ | 1.1 | W/°C |
| TJ | Operating Junction Temperature Range | -40 to +175 | °C |
| T _{STG} | Storage Junction Temperature Range | -40 to +175 | °C |
| ΤL | Max. Lead Temp. for Soldering (Leads at 1.6 mm from case for 10 s) | 300 | °C |
| T _{PKG} | Max. Lead Temp. for Soldering (Package Body for 10 s) | 260 | °C |
| ESD | Electrostatic Discharge Voltage at 100 pF, 1500 Ω | 4 | kV |
| | CDM-Electrostatic Discharge Voltage at 1 Ω | 2 | kV |

DEVICE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality

should not be assumed, damage may occur and reliability may be affected. 1. Self Clamping Inductive Switching Energy (E_{SCIS25}) of 320 mJ is based on the test conditions that starting Tj = 25°C; L = 3 mHy, I_{SCIS} = 14.6 A, V_{CC} = 100 V during inductor charging and V_{CC} = 0 V during the time in clamp. 2. Self Clamping Inductive Switching Energy ($E_{SCIS150}$) of 180 mJ is based on the test conditions that starting Tj = 150°C; L = 3 mHy, I_{SCIS} = 10.9 A, V_{CC} = 100 V during inductor charging and V_{CC} = 0 V during the time in clamp.

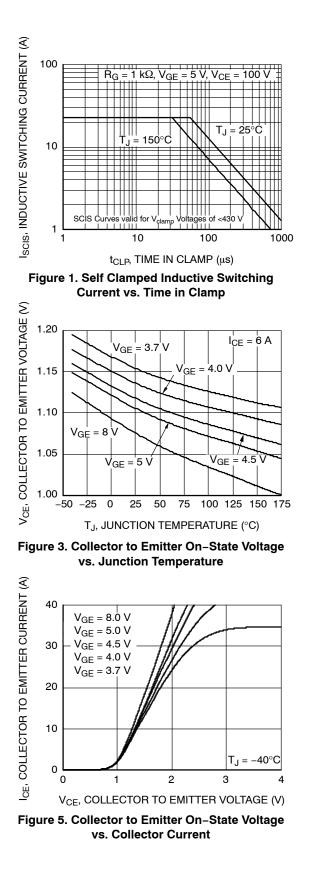
| Symbol | Parameter | Test Conditions | | Min | Тур | Max | Unit |
|----------------------|---|---|------------------------|------|------|------|------|
| OFF STAT | E CHARACTERISTICS | | | | | | |
| BV _{CER} | Collector to Emitter Breakdown Voltage | I_{CE} = 2 mA, V_{GE} = 0, R_{GE} = 1 k Ω , T_J = -40 to 150°C | | 420 | - | 480 | V |
| BV _{CES} | Collector to Emitter Breakdown Voltage | I_{CE} = 10 mA, V_{GE} = 0 V, R_{GE} = 0, T_{J} = –40 to 150 $^{\circ}C$ | | 440 | - | 500 | V |
| BV _{ECS} | Emitter to Collector Breakdown Voltage | I_{CE} = -75 mA, V_{GE} = 0 V, T_{J} = 25°C | | 28 | - | - | V |
| BV_{GES} | Gate to Emitter Breakdown Voltage | $I_{GES} = \pm 2 \text{ mA}$ | | ±12 | ±14 | - | V |
| I _{CER} | Collector to Emitter Leakage Current | V_{CE} = 250 V, R_{GE} = 1 k Ω | $T_J = 25^{\circ}C$ | - | - | 25 | μA |
| | | | T _J = 150°C | - | - | 1 | mA |
| I _{ECS} | Emitter to Collector Leakage Current | V _{EC} = 24 V | $T_J = 25^{\circ}C$ | - | - | 1 | mA |
| | | | T _J = 150°C | - | - | 40 | |
| R ₁ | Series Gate Resistance | | | - | 120 | - | Ω |
| R ₂ | Gate to Emitter Resistance | | | 10 k | - | 30 k | Ω |
| ON STATE | CHARACTERISTICS | • | | | | | |
| V _{CE(SAT)} | Collector to Emitter Saturation Voltage | $I_{CE} = 6 \text{ A}, V_{GE} = 4 \text{ V}$ | $T_J = 25^{\circ}C$ | - | 1.13 | 1.25 | V |
| V _{CE(SAT)} | Collector to Emitter Saturation Voltage | I _{CE} = 10 A, V _{GE} = 4.5 V | T _J = 150°C | - | 1.32 | 1.50 | V |
| V _{CE(SAT)} | Collector to Emitter Saturation Voltage | I _{CE} = 15 A, V _{GE} = 4.5 V | T _J = 150°C | - | 1.64 | 1.85 | V |
| OYNAMIC | CHARACTERISTICS | • | | | | | |
| Q _{G(ON)} | Gate Charge | I_{CE} = 10 A, V_{CE} = 12 V, V_{GE} = 5 V | | - | 23 | - | nC |
| V _{GE(TH)} | Gate to Emitter Threshold Voltage | I_{CE} = 1 mA, V_{CE} = V_{GE} | $T_J = 25^{\circ}C$ | 1.3 | 1.6 | 2.2 | V |
| | | | T _J = 150°C | 0.75 | 1.1 | 1.8 | |
| V_{GEP} | Gate to Emitter Plateau Voltage | V _{CE} = 12 V, I _{CE} = 10 A | | - | 2.7 | - | V |
| SWITCHIN | G CHARACTERISTICS | | | | | | |
| t _{d(ON)R} | Current Turn-On Delay Time-Resistive | $V_{CE} = 14 \text{ V}, \text{ R}_{L} = 1 \text{ k}\Omega$ | | - | 0.9 | 4 | μs |
| t _{rR} | Current Rise Time-Resistive | - V _{GE} = 5 V, R _G = 1 kΩ, T _J = 25°C | | - | 2.6 | 7 | μs |
| t _{d(OFF)L} | Current Turn-Off Delay Time-Inductive | $V_{CE} = 300 \text{ V}, \text{ L} = 1 \text{ mH},$ $V_{GE} = 5 \text{ V}, \text{ R}_{G} = 1 \text{ k}\Omega,$ $I_{CE} = 6.5 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$ | | - | 5.4 | 15 | μs |
| t _{fL} | Current Fall Time-Inductive | | | - | 2.7 | 15 | μs |
| E _{SCIS} | Self Clamped Inductive Switching | L = 3.0 mHy, RG = 1 kΩ, VGE = 5 V, (Note 3) | TJ = 25°C | - | - | 320 | mJ |
| THERMAL | CHARACTERISTICS | 1 | | | | | |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case | All packages | | _ | _ | 0.9 | °C/W |
| | | | | | | 1 | |

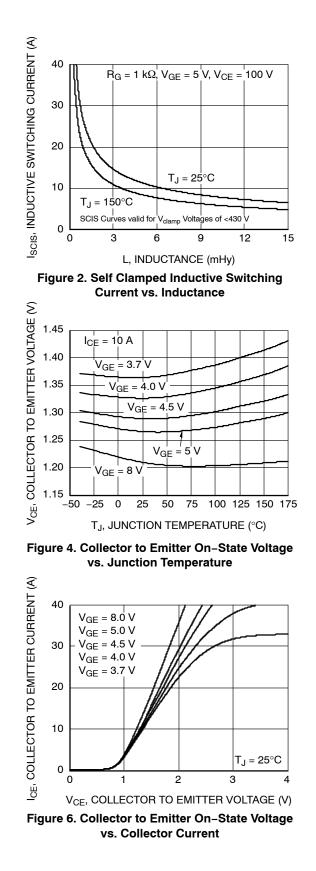
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

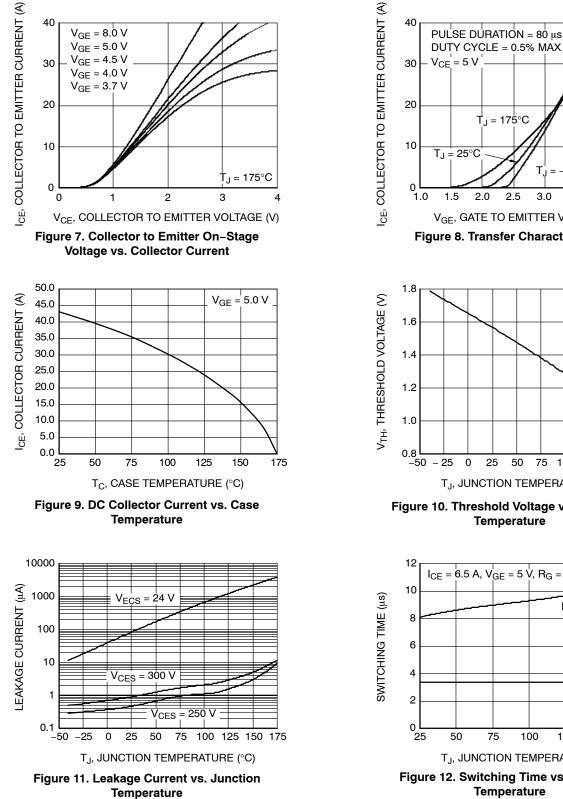
performance may not be indicated by the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Self Clamping Inductive Switching Energy (E_{SCIS25}) of 320 mJ is based on the test conditions that starting Tj = 25°C; L = 3 mHy, I_{SCIS} = 14.6 A, V_{CC} = 100 V during inductor charging and V_{CC} = 0 V during the time in clamp.

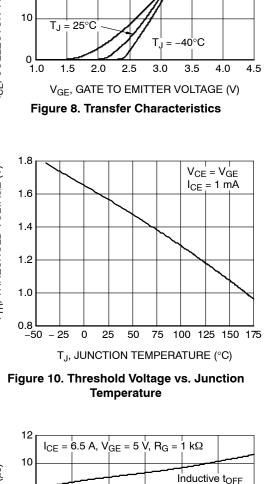
TYPICAL PERFORMANCE CURVES

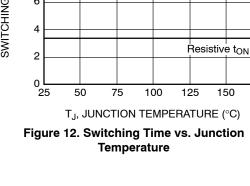




TYPICAL PERFORMANCE CURVES (Continued)







175

TYPICAL PERFORMANCE CURVES (Continued)

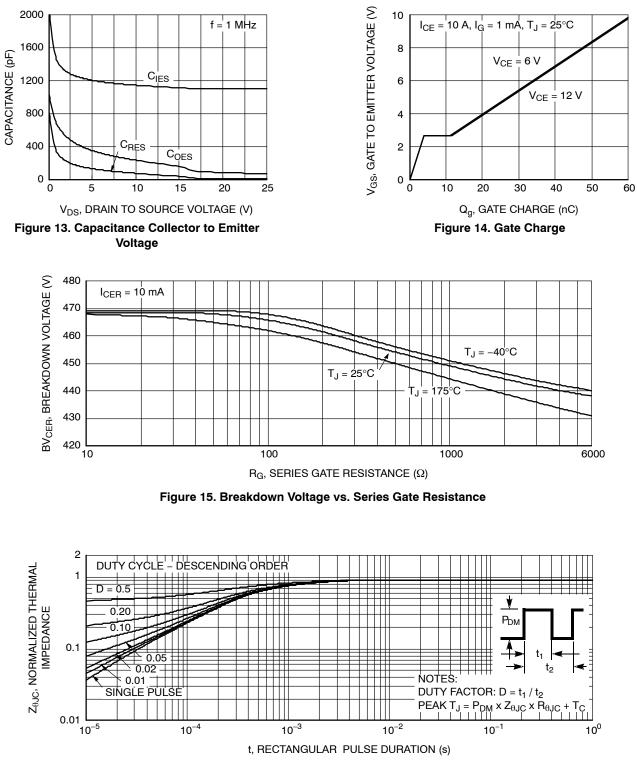
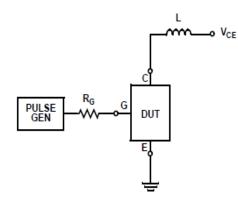


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

TESTE CIRCUITS AND WAVEFORMS



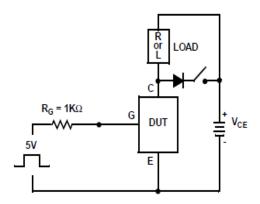


Figure 17. Inductive Switching Test Circuit



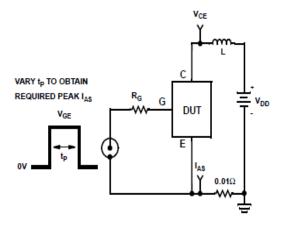


Figure 19. Energy Test Circuit

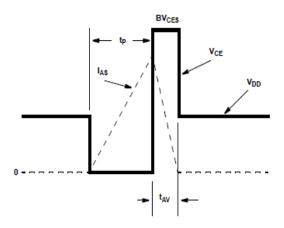


Figure 20. Energy Waveforms

PACKAGE MARKING AND ORDERING INFORMATION

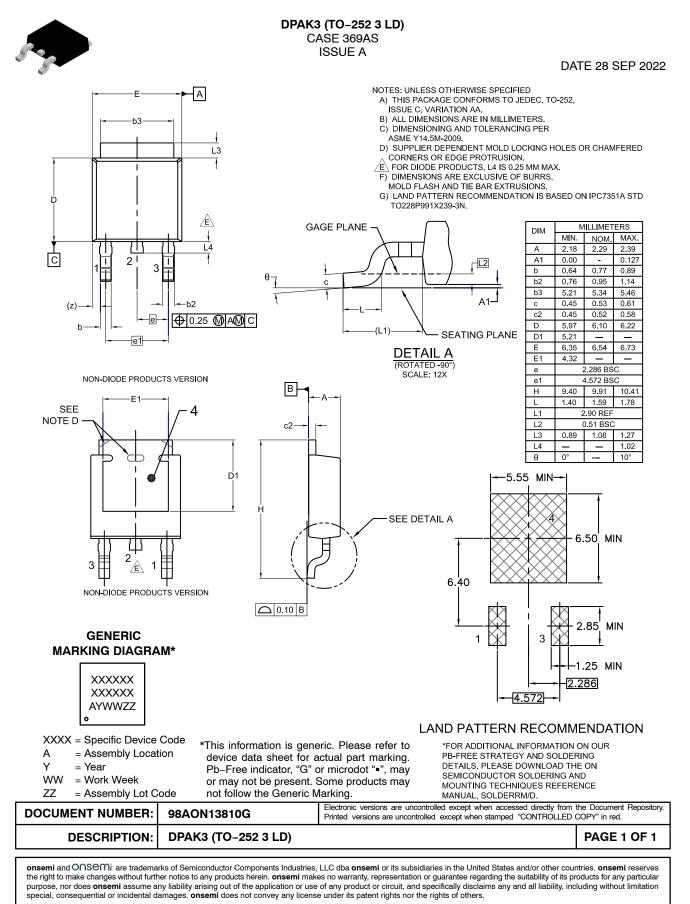
| Device Marking | Device | Package | Reel Size | Tape Width | Shipping [†] |
|----------------|----------------|---|-----------|------------|-----------------------|
| FGD3245G2 | FGD3245G2-F085 | DPAK3 (TO-252 3 LD) TO252AA (Pb-Free) | 330 mm | 16 mm | 2500 / Tape & Reel |
| FGB3245G2 | FGB3245G2-F085 | D ² PAK-3 (TO-263, 3-LEAD) TO263AB (Pb-Free) | 330 mm | 24 mm | 800 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ECOSPARK is registered trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/ or other countries.

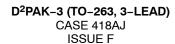
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

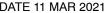
Onsemi

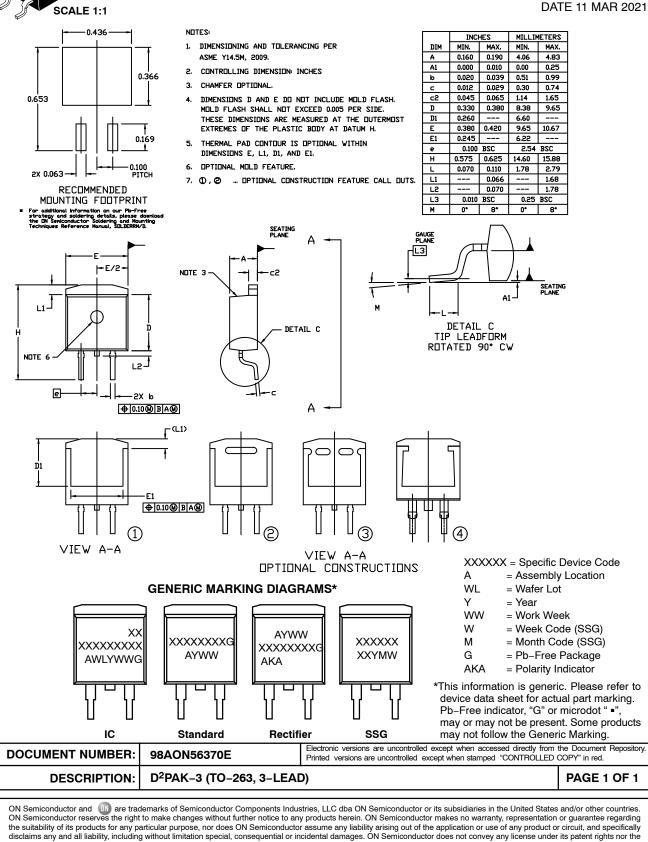


MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS









© Semiconductor Components Industries, LLC, 2018

rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi: FGB3245G2-F085 FGD3245G2-F085